DATASHEET

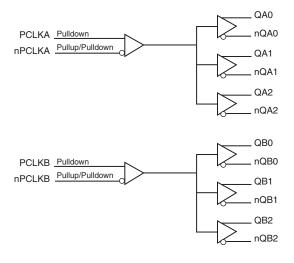
# **General Description**

The ICS853S013I is a low skew, high performance dual 1-to-3 Differential-to-2.5V. 3.3V LVPECL/ ECL Fanout Buffer. The ICS853S013I operates with a positive or negative power supply at 2.5V or 3.3V. Guaranteed output and part-to-part skew characteristics make the ICS853S013I ideal for those clock distribution applications demanding well defined performance and repeatability.

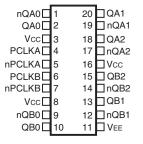
#### **Features**

- Two differential LVPECL/ECL bank outputs
- Two differential LVPECL clock input pairs
- PCLKx, nPCLKx pairs can accept the following differential input levels: LVPECL, LVDS, CML, SSTL
- Output frequency: 2GHz (maximum)
- Translates any single-ended input signal to LVPECL levels with resistor bias on nPCLKx input
- Bank skew: 60ps (maximum)
- Part-to-part skew: 190ps (maximum)
- Propagation delay: 460ps (maximum)
- · Additive phase jitter, RMS: 0.05ps (typical)
- LVPECL mode operating voltage supply range:  $V_{CC} = 2.375V$  to 3.8V,  $V_{FF} = 0V$
- ECL mode operating voltage supply range:  $V_{CC} = 0V$ ,  $V_{EE} = -3.8V$  to -2.375V
- -40°C to 85°C ambient operating temperature
- Available in lead-free (RoHS 6) package

# **Block Diagram**



# **Pin Assignment**



ICS853S013I

20-Lead SOIC 7.5mm x 12.8mm x 2.3mm package body **M Package Top View** 



**Table 1. Pin Descriptions** 

Number	Name	T	уре	Description
1, 2	nQA0, QA0	Output		Differential output pair. LVPECL interface levels.
3, 8, 16	V <sub>CC</sub>	Power		Power supply pins.
4	PCLKA	Input	Pulldown	Non-inverting differential LVPECL clock input.
5	nPCLKA	Input	Pullup/ Pulldown	Inverting differential LVPECL clock input. V <sub>CC</sub> /2 default when left floating.
6	PCLKB	Input	Pulldown	Non-inverting differential LVPECL clock input.
7	nPCLKB	Input	Pullup/ Pulldown	Inverting differential LVPECL clock input. V <sub>CC</sub> /2 default when left floating.
9, 10	nQB0, QB0	Output		Differential output pair. LVPECL interface levels.
11	V <sub>EE</sub>	Power		Negative supply pin.
12, 13	nQB1, QB1	Output		Differential output pair. LVPECL interface levels.
14, 15	nQB2, QB2	Output		Differential output pair. LVPECL interface levels.
17, 18	nQA2, QA2	Output		Differential output pair. LVPECL interface levels.
19, 20	nQA1, QA1	Output		Differential output pair. LVPECL interface levels.

NOTE: Pullup and Pulldown refer to internal input resistors. See Table 2, Pin Characteristics, for typical values.

# **Table 2. Pin Characteristics**

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
R <sub>PULLDOWN</sub>	Input Pulldown Resistor			75		kΩ
R <sub>VCC/2</sub>	Pullup/Pulldown Resistors			50		kΩ

## **Function Table**

**Table 3. Clock Input Function Table** 

Inputs		Ou	utputs		
PCLKA or PCLKB	nPCLKA or nPCLKB	QA[0:2], QB[0:2]	nQA[0:2], nQB[0:2]	Input to Output Mode	Polarity
0	1	LOW	HIGH	Differential to Differential	Non-Inverting
1	0	HIGH	LOW	Differential to Differential	Non-Inverting
0	Biased; NOTE 1	LOW	HIGH	Single-Ended to Differential	Non-Inverting
1	Biased; NOTE 1	HIGH	LOW	Single-Ended to Differential	Non-Inverting
Biased; NOTE 1	0	HIGH	LOW	Single-Ended to Differential	Inverting
Biased; NOTE 1	1	LOW	HIGH	Single-Ended to Differential	Inverting

NOTE 1: Please refer to the Application Information, Wiring the Differential Input to Accept Single Ended Levels.



# **Absolute Maximum Ratings**

NOTE: Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

Item	Rating
Supply Voltage, V <sub>CC</sub>	4.6V (LVPECL mode, V <sub>EE</sub> = 0V)
Negative Supply Voltage, V <sub>EE</sub>	-4.6V (ECL mode, V <sub>CC</sub> = 0V)
Inputs, V <sub>I</sub> (LVPECL mode)	-0.5V to V <sub>CC</sub> + 0.5V
Inputs, V <sub>I</sub> (ECL mode)	0.5V to V <sub>EE</sub> – 0.5V
Outputs, I <sub>O</sub> Continuous Current Surge Current	50mA 100mA
Operating Temperature Range, T <sub>A</sub>	-40°C to +85°C
Package Thermal Impedance, $\theta_{JA}$	71.1°C/W (0 mps)
Storage Temperature, T <sub>STG</sub>	-65°C to 150°C

### **DC Electrical Characteristics**

Table 4A. Power Supply DC Characteristics,  $V_{CC} = 2.375V$  to 3.8V;  $V_{EE} = 0V$ ,  $T_A = -40^{\circ}C$  to  $85^{\circ}C$ 

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V <sub>CC</sub>	Positive Supply Voltage		2.375	3.3	3.8	V
I <sub>EE</sub>	Power Supply Current				50	mA

Table 4B. LVPECL DC Characteristics,  $V_{CC} = 3.3V$ ,  $V_{EE} = 0V$ ;  $T_A = -40$ °C to 85°C

				-40°C			25°C		85°C			
Symbol	Parameter		Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Units
V <sub>OH</sub>	Output High Voltage; NOTE 1		2.175	2.275	2.50	2.225	2.295	2.495	2.295	2.33	2.485	V
V <sub>OL</sub>	Output Low Voltage; NOTE 1		1.405	1.545	1.68	1.425	1.52	1.65	1.44	1.535	1.62	V
V <sub>IH</sub>	Input High Volta	ge (Single-ended)	2.075		2.36	2.075		2.36	2.075		2.36	V
V <sub>IL</sub>	Input Low Voltage	ge (Single-ended)	1.43		1.765	1.43		1.765	1.43		1.765	V
V <sub>PP</sub>	Peak-to-Peak I	nput Voltage	150	800	1200	150	800	1200	150	800	1200	mV
V <sub>CMR</sub>	Input High Volt Range; NOTE	age Common Mode 2, 3	1.2		3.3	1.2		3.3	1.2		3.3	V
I <sub>IH</sub>	Input High Current	PCLKA, PCLKB nPCLKA, nPCLKB			150			150			150	μA
	Input	PCLKA, PCLKB	-10			-10			-10			μΑ
¹IL	Low Current	nPCLKA, nPCLKB	-150			-150			-150			μΑ

NOTE: Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{CC}$  can vary -0.925V to +0.5V.

NOTE 1: Outputs terminated with 50  $\!\Omega$  to V  $_{CC}$  – 2V.

NOTE 2: Common mode voltage is defined as V<sub>IH</sub>.

NOTE 3: For single-ended applications, the maximum input voltage for PCLKx, nPCLKx is  $V_{CC}$  + 0.3V.



Table 4C. LVPECL DC Characteristics,  $V_{CC} = 2.5V$ ,  $V_{EE} = 0V$ ;  $T_A = -40$ °C to 85°C

				-40°C			25°C			85°C		
Symbol	Parameter		Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Units
V <sub>OH</sub>	Output High Vo	oltage; NOTE 1	1.375	1.475	1.70	1.425	1.495	1.69	1.495	1.53	1.685	V
V <sub>OL</sub>	Output Low Voltage; NOTE 1		0.605	0.745	0.92	0.625	0.72	0.90	0.64	0.735	0.89	٧
V <sub>IH</sub>	Input High Volta	ge (Single-ended)	1.275		1.56	1.275		1.56	1.275		-0.8	٧
V <sub>IL</sub>	Input Low Voltag	ge (Single-ended)	0.63		0.965	0.63		0.965	0.63		0.965	V
V <sub>PP</sub>	Peak-to-Peak I	nput Voltage	150	800	1200	150	800	1200	150	800	1200	mV
V <sub>CMR</sub>	Input High Volt Range; NOTE	age Common Mode 2, 3	1.2		2.5	1.2		2.5	1.2		2.5	V
I <sub>IH</sub>	Input High Current	PCLKA, PCLKB nPCLKA, nPCLKB			150			150			150	μΑ
	Input	PCLKA, PCLKB	-10			-10			-10			μΑ
IIL	Low Current	nPCLKA, nPCLKB	-150			-150			-150			μA

NOTE: Input and output parameters vary 1:1 with  $V_{CC}$ .  $V_{CC}$  can vary -0.925V to +0.5V.

NOTE 1: Outputs terminated with 50  $\!\Omega$  to  $V_{CC}$  – 2V.

NOTE 2: Common mode voltage is defined as  $V_{\text{IH}}$ .

NOTE 3: For single-ended applications, the maximum input voltage for PCLKx, nPCLKx is  $V_{CC}$  + 0.3V.

Table 4D. ECL DC Characteristics,  $V_{CC} = 0V$ ,  $V_{EE} = -3.8V$  to -2.375V,  $T_A = -40$ °C to 85°C

				-40°C			25°C			85°C		
Symbol	Parameter		Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Units
V <sub>OH</sub>	Output High V	oltage; NOTE 1	-1.125	-1.025	-0.80	-1.075	-1.005	-0.805	-1.005	-0.97	-0.815	V
V <sub>OL</sub>	Output Low Vo	oltage; NOTE 1	-1.895	-1.755	-1.62	-1.875	-1.78	-1.65	-1.86	-1.765	-1.68	V
V <sub>IH</sub>	Input High Volta	age (Single-ended)	-1.225		-0.94	-1.225		-0.94	-1.225		-0.94	V
V <sub>IL</sub>	Input Low Volta	ge (Single-ended)	-1.87		-1.535	-1.87		-1.535	-1.87		-1.535	V
V <sub>PP</sub>	Peak-to-Peak	Input Voltage	150	800	1200	150	800	1200	150	800	1200	mV
V <sub>CMR</sub>	Input High Vol Range; NOTE	tage Common Mode 2, 3	V <sub>EE</sub> +1.2		0	V <sub>EE</sub> +1.2		0	V <sub>EE</sub> +1.2		0	V
I <sub>IH</sub>	Input High Current	PCLKA, PCLKB nPCLKA, nPCLKB			150			150			150	μΑ
1	Input	PCLKA, PCLKB	-10			-10			-10			μΑ
IIL	Low Current	nPCLKA, nPCLKB	-150			-150			-150			μA

NOTE 1: Outputs terminated with 50  $\!\Omega$  to V  $_{CC}$  – 2V.

NOTE 2: Common mode voltage is defined as  $V_{\text{IH}}$ .

NOTE 3: For single-ended applications, the maximum input voltage for PCLKx, nPCLKx is  $V_{CC} + 0.3V$ 



### **AC Electrical Characteristics**

Table 5. AC Characteristics,  $V_{CC}$  = -3.8V to -2.375V or ,  $V_{CC}$  = 2.375V to 3.8V;  $V_{EE}$  = 0V;  $T_A$  = -40°C to 85°C

	1					l			1			1
				-40°C			25°C			85°C		
Symbol	Parameter		Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Units
f <sub>MAX</sub>	Output Frequence	су.			2			2			2	GHz
tP <sub>LH</sub>	Propagation Dela	ay; Low-to-High;	230		420	250		440	270		460	ps
tP <sub>HL</sub>	Propagation Dela	ay; High-to-Low;	230		420	250		440	270		460	ps
tsk(b)	Bank Skew; NOT	ΓE 2, 4			60			60			60	ps
tsk(odc)	Output Duty Cycl	le Skew			40			40			40	ps
tsk(pp)	Part-to-Part Skev	w; NOTE 3, 4			190			190			190	ps
fjit	Buffer Additive P RMS; refer to Ad Jjitter Section	·		0.03			0.05			0.08		ps
t <sub>R</sub> / t <sub>F</sub>	Output Rise/Fall Time	20% to 80%	120		250	120		250	120		250	ps

NOTE: All parameters are measured at  $f \le 1$ GHz, unless otherwise noted.

NOTE: Electrical parameters are guaranteed over the specified ambient operating temperature range, which is established when the device is mounted in a test socket with maintained transverse airflow greater than 500 lfpm. The device will meet specifications after thermal equilibrium has been reached under these conditions.

NOTE 1: Measured from the differential input crossing point to the differential output crossing point.

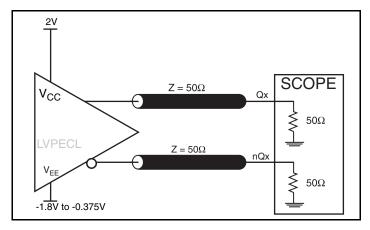
NOTE 2: Defined as skew within a bank of outputs at the same voltages and with equal load conditions.

NOTE 3: Defined as skew between outputs on different devices operating at the same supply voltages and with equal load conditions. Using the same type of inputs on each device, the outputs are measured at the differential cross points.

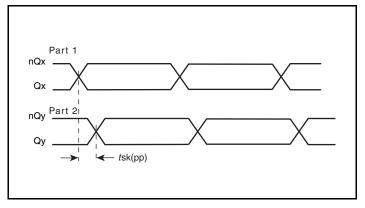
NOTE 4: This parameter is defined in accordance with JEDEC Standard 65.



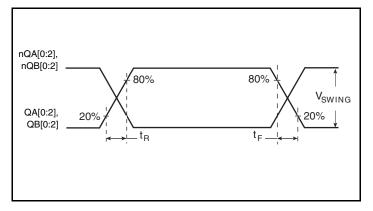
# **Parameter Measurement Information**



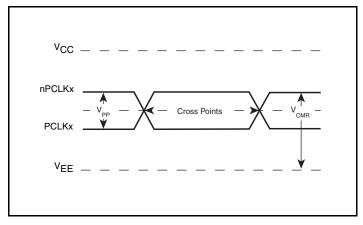
**LVPECL Output Load AC Test Circuit** 



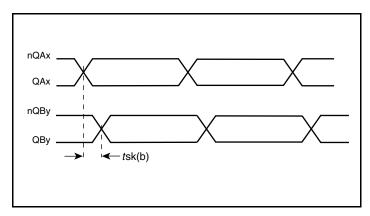
**Part-to-Part Skew** 



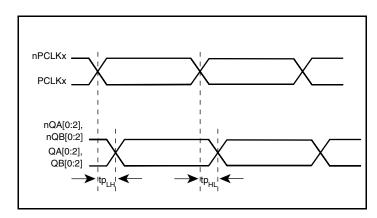
**Output Rise/Fall Time** 



**Differential Input Level** 



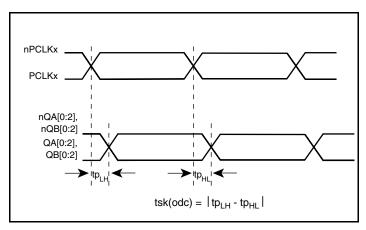
**Bank Skew** 



**Propagation Delay** 



# **Parameter Measurement Information, continued**



**Output Duty Cycle Skew** 



## **Application Information**

### Wiring the Differential Input to Accept Single-Ended Levels

Figure 1 shows how a differential input can be wired to accept single ended levels. The reference voltage  $V_{REF} = V_{CC}/2$  is generated by the bias resistors R1 and R2. The bypass capacitor (C1) is used to help filter noise on the DC bias. This bias circuit should be located as close to the input pin as possible. The ratio of R1 and R2 might need to be adjusted to position the  $V_{REF}$  in the center of the input voltage swing. For example, if the input clock swing is 2.5V and  $V_{CC} = 3.3V$ , R1 and R2 value should be adjusted to set  $V_{REF}$  at 1.25V. The values below are for when both the single ended swing and  $V_{CC}$  are at the same voltage. This configuration requires that the sum of the output impedance of the driver (Ro) and the series resistance (Rs) equals the transmission line impedance. In addition, matched termination at the input will attenuate the signal in half. This can be done in one of two ways. First, R3 and R4 in parallel should equal the transmission

line impedance. For most  $50\Omega$  applications, R3 and R4 can be  $100\Omega$ . The values of the resistors can be increased to reduce the loading for slower and weaker LVCMOS driver. When using single-ended signaling, the noise rejection benefits of differential signaling are reduced. Even though the differential input can handle full rail LVCMOS signaling, it is recommended that the amplitude be reduced. The datasheet specifies a lower differential amplitude, however this only applies to differential signals. For single-ended applications, the swing can be larger, however  $V_{\rm IL}$  cannot be less than -0.3V and  $V_{\rm IH}$  cannot be more than  $V_{\rm CC}$  + 0.3V. Though some of the recommended components might not be used, the pads should be placed in the layout. They can be utilized for debugging purposes. The datasheet specifications are characterized and quaranteed by using a differential signal.

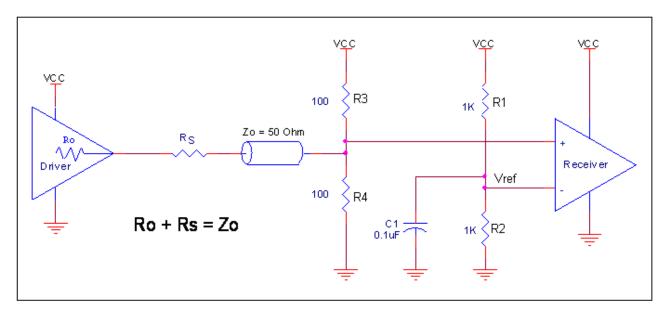


Figure 1. Recommended Schematic for Wiring a Differential Input to Accept Single-ended Levels



### **LVPECL Clock Input Interface**

The PCLK/nPCLK accepts LVPECL, LVDS, CML, SSTL and other differential signals. Both  $V_{SWING}$  and  $V_{OH}$  must meet the  $V_{PP}$  and  $V_{CMR}$  input requirements. Figures 2A to 2F show interface examples for the PCLK/nPCLK input driven by the most common driver types.

The input interfaces suggested here are examples only. If the driver is from another vendor, use their termination recommendation. Please consult with the vendor of the driver component to confirm the driver termination requirements.

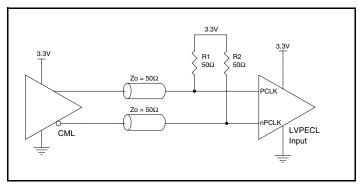


Figure 2A. PCLK/nPCLK Input
Driven by an Open Collector CML Driver

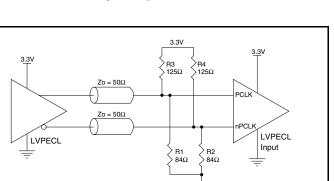


Figure 2C. PCLK/nPCLK Input
Driven by a 3.3V LVPECL Driver

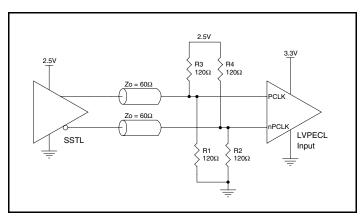


Figure 2E. PCLK/nPCLK Input
Driven by an SSTL Driver

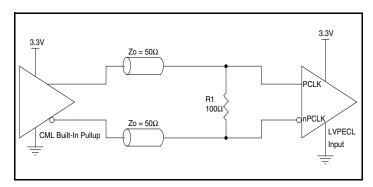


Figure 2B. PCLK/nPCLK Input
Driven by a Built-In Pullup CML Driver

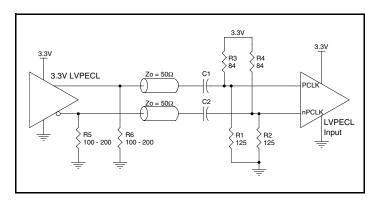


Figure 2D. PCLK/nPCLKInput Driven by a 3.3V LVPECL Driver with AC Couple

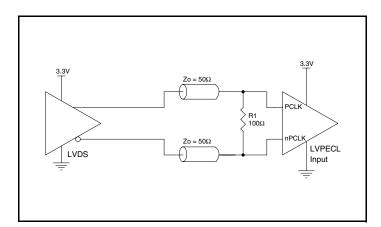


Figure 2F. PCLK/nPCLK Input
Driven by a 3.3V LVDS Driver



### **Recommendations for Unused Output Pins**

#### Inputs:

#### PCLKx/nPCLKx Inputs

For applications not requiring the use of a differential input, both the PCLKx and nPCLKx pins can be left floating. Though not required, but for additional protection, a  $1 k\Omega$  resistor can be tied from PCLKx to ground. For applications

### **Outputs:**

#### **LVPECL Outputs**

All unused LVPECL outputs can be left floating. We recommend that there is no trace attached. Both sides of the differential output pair should either be left floating or terminated.

### **Termination for 3.3V LVPECL Outputs**

The clock layout topology shown below is a typical termination for LVPECL outputs. The two different layouts mentioned are recommended only as guidelines.

The differential outputs are low impedance follower outputs that generate ECL/LVPECL compatible outputs. Therefore, terminating resistors (DC current path to ground) or current sources must be used for functionality. These outputs are designed to drive  $50\Omega$ 

transmission lines. Matched impedance techniques should be used to maximize operating frequency and minimize signal distortion. *Figures 3A and 3B* show two different layouts which are recommended only as guidelines. Other suitable clock layouts may exist and it would be recommended that the board designers simulate to guarantee compatibility across all printed circuit and clock component process variations.

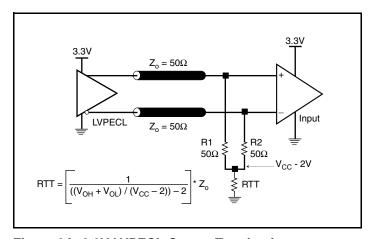


Figure 3A. 3.3V LVPECL Output Termination

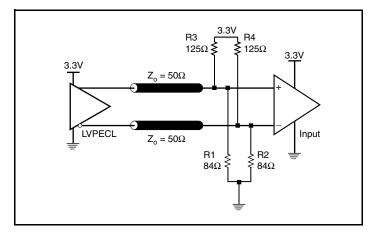


Figure 3B. 3.3V LVPECL Output Termination



### **Termination for 2.5V LVPECL Outputs**

Figure 4A and Figure 4B show examples of termination for 2.5V LVPECL driver. These terminations are equivalent to terminating  $50\Omega$  to  $V_{CC}$  – 2V. For  $V_{CC}$  = 2.5V, the  $V_{CC}$  – 2V is very close to ground

level. The R3 in Figure 4B can be eliminated and the termination is shown in *Figure 4C*.

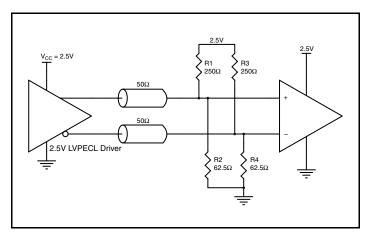


Figure 4A. 2.5V LVPECL Driver Termination Example

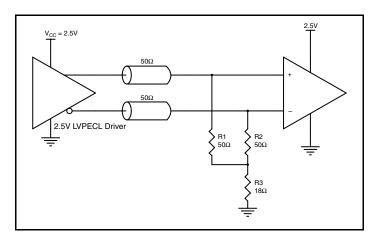


Figure 4B. 2.5V LVPECL Driver Termination Example

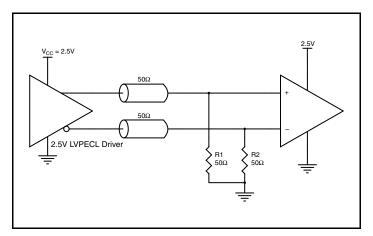


Figure 4C. 2.5V LVPECL Driver Termination Example



### **Power Considerations**

This section provides information on power dissipation and junction temperature for the ICS853S013I. Equations and example calculations are also provided.

#### 1. Power Dissipation.

The total power dissipation for the CS853S013I is the sum of the core power plus the power dissipated in the load(s). The following is the power dissipation for  $V_{CC} = 3.8V$ , which gives worst case results.

NOTE: Please refer to Section 3 for details on calculating power dissipated in the load.

- Power (core)<sub>MAX</sub> = V<sub>CC MAX</sub> \* I<sub>EE MAX</sub> = 3.8V \* 50mA = 190mW
- Power (outputs)<sub>MAX</sub> = 30.07mW/Loaded Output pair
   If all outputs are loaded, the total power is 6 \*30.07mW = 180.43mW

Total Power\_MAX (3.8V, with all outputs switching) =190mW + 180.43mW = 370.43mW

#### 2. Junction Temperature.

Junction temperature, Tj, is the temperature at the junction of the bond wire and bond pad directly affects the reliability of the device. The maximum recommended junction temperature is 125°C. Limiting the internal transistor junction temperature, Tj, to 125°C ensures that the bond wire and bond pad temperature remains below 125°C.

The equation for Tj is as follows: Tj =  $\theta_{JA}$  \* Pd\_total + T<sub>A</sub>

Tj = Junction Temperature

 $\theta_{\mathsf{JA}}$  = Junction-to-Ambient Thermal Resistance

Pd\_total = Total Device Power Dissipation (example calculation is in section 1 above)

T<sub>A</sub> = Ambient Temperature

In order to calculate junction temperature, the appropriate junction-to-ambient thermal resistance  $\theta_{JA}$  must be used. Assuming no air flow and a multi-layer board, the appropriate value is 71.1°C/W per Table 6 below.

Therefore, Tj for an ambient temperature of 85°C with all outputs switching is:

$$85^{\circ}\text{C} + 0.370\text{W} * 71.1^{\circ}\text{C/W} = 111.3^{\circ}\text{C}$$
. This is well below the limit of  $125^{\circ}\text{C}$ .

This calculation is only an example. Tj will obviously vary depending on the number of loaded outputs, supply voltage, air flow and the type of board (multi-layer).

Table 6. Thermal Resistance  $\theta_{JA}$  for 20 Lead SOIC, Forced Convection

θ <sub>JA</sub> by Velocity						
Meters per Second	0	200	500			
Multi-Layer PCB, JEDEC Standard Test Boards	71.1°C/W	65.2°C/W	62°C/W			



#### 3. Calculations and Equations.

The purpose of this section is to derive the power dissipated into the load.

LVPECL output driver circuit and termination are shown in Figure 5.

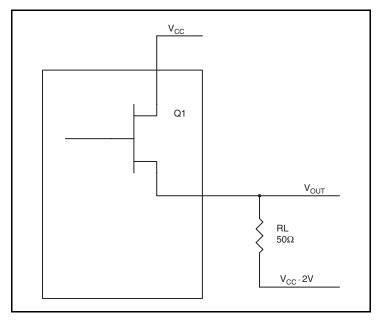


Figure 5. LVPECL Driver Circuit and Termination

To calculate worst case power dissipation into the load, use the following equations which assume a  $50\Omega$  load, and a termination voltage of  $V_{CC} - 2V$ .

- For logic high, V<sub>OUT</sub> = V<sub>OH\_MAX</sub> = V<sub>CC\_MAX</sub> 0.815V
   (V<sub>CC\_MAX</sub> V<sub>OH\_MAX</sub>) = 0.815V
- For logic low,  $V_{OUT} = V_{OL\_MAX} = V_{CC\_MAX} 1.68V$  $(V_{CC\_MAX} - V_{OL\_MAX}) = 1.68V$

Pd\_H is power dissipation when the output drives high.

Pd\_L is the power dissipation when the output drives low.

$$Pd\_H = [(V_{OH\_MAX} - (V_{CC\_MAX} - 2V))/R_L] * (V_{CC\_MAX} - V_{OH\_MAX}) = [(2V - (V_{CC\_MAX} - V_{OH\_MAX}))/R_L] * (V_{CC\_MAX} - V_{OH\_MAX}) = [(2V - 0.815V)/50\Omega] * 0.815V = \textbf{19.32mW}$$

$$Pd\_L = [(V_{OL\_MAX} - (V_{CC\_MAX} - 2V))/R_L] * (V_{CC\_MAX} - V_{OL\_MAX}) = [(2V - (V_{CC\_MAX} - V_{OL\_MAX}))/R_L] * (V_{CC\_MAX} - V_{OL\_MAX}) = [(2V - 1.68V)/50\Omega] * 1.68V = \textbf{10.75mW}$$

Total Power Dissipation per output pair = Pd\_H + Pd\_L = 30.07mW



# **Reliability Information**

Table 7.  $\theta_{\text{JA}}$  vs. Air Flow Table for a 20 Lead SOIC

$\theta_{JA}$ by Velocity						
Meters per Second	0	200	500			
Multi-Layer PCB, JEDEC Standard Test Boards	71.1°C/W	65.2°C/W	62°C/W			

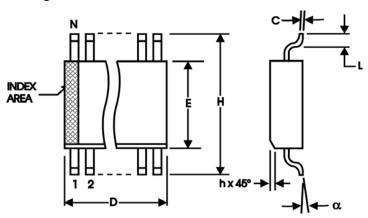
### **Transistor Count**

The transistor count for ICS853S013I is: 270

This device is pin and function compatible and a suggested replacement for the ICS853013.

# **Package Outline and Package Dimensions**

Package Outline - M Suffix for 20 Lead SOIC



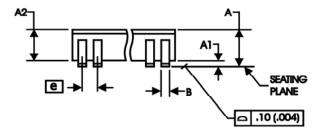


Table 8. Package Dimensions for 20 Lead SOIC

	300 Millimeter	-
All Dim	nensions in Mi	Ilimeters
Symbol	Minimum	Maximum
N	20	
Α		2.65
A1	0.10	
A2	2.05	2.55
В	0.33	0.51
С	0.18	0.32
D	12.60	13.00
E	7.40	7.60
е	1.27	Basic
Н	10.00	10.65
h	0.25	0.75
L	0.40	1.27
α	0°	7°

Reference Document: JEDEC Publication 95, MS-013, MS-119



# **Ordering Information**

# **Table 9. Ordering Information**

Part/Order Number	Marking	Package	Shipping Packaging	Temperature
853S013AMILF	ICS853S013AMILF	"Lead-Free" 20 Lead SOIC	Tube	-40°C to 85°C
853S013AMILFT	ICS853S013AMILF	"Lead-Free" 20 Lead SOIC	1000 Tape & Reel	-40°C to 85°C

NOTE: Parts that are ordered with an "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.



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